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Plastics — Determination of thermal conductivity and thermal diffusivity —

Part 2:
Transient plane heat source (hot disc) method

Plastiques — Détermination de la conductivité thermique et de la diffusivité thermique —

Partie 2: Méthode de la source plane transitoire (disque chaud)

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Foreword

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The procedures used to develop this document and those intended for its further maintenance are described in the ISO/IEC Directives, Part 1. In particular, the different approval criteria needed for the different types of ISO documents should be noted. This document was drafted in accordance with the editorial rules of the ISO/IEC Directives, Part 2 (see www.iso.org/directives).

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This document was prepared by Technical Committee ISO/TC 61, *Plastics*, Subcommittee SC 5, *Physical-chemical properties,* in collaboration with the European Committee for Standardization (CEN) Technical Committee CEN/TC 249, *Plastics,* in accordance with the Agreement on technical cooperation between ISO and CEN (Vienna Agreement).

This third edition cancels and replaces the second edition (ISO 22007-2:2015), which has been technically revised.

The main changes are as follows:

— Figure 2 has been corrected;

— the term "penetration depth" (former 3.1) has been deleted;

— several Notes have been changed to body text;

— reference has been made in the main text to the theory of sensitivity coefficients.

A list of all parts in the ISO 22007 series can be found on the ISO website.

Any feedback or questions on this document should be directed to the user's national standards body. A complete listing of these bodies can be found at www.iso.org/members.html.

Introduction

A significant increase in the development and application of new and improved materials for broad ranges of physical, chemical, biological, and medical applications has necessitated better performance data from methods of measurement of thermal-transport properties. The introduction of alternative methods that are relatively simple, fast, and of good precision would be of great benefit to the scientific and engineering communities[1].

A number of measurement techniques described as transient methods have been developed of which several have been commercialized. These are being widely used and are suitable for testing many types of materials. In some cases, they can be used to measure several properties separately or simultaneously[2],[3].

A further advantage of some of these methods is that it has become possible to measure the true bulk properties of a material. This feature stems from the possibility of eliminating the influence of the thermal contact resistance (see 8.1.1) that is present at the interface between the probe and the specimen surfaces[1],[3],[4],[5],[6].

Plastics — Determination of thermal conductivity and thermal diffusivity —

Part 2:
Transient plane heat source (hot disc) method

1 Scope

This document specifies a method for the determination of the thermal conductivity and thermal diffusivity, and hence the specific heat capacity per unit volume of plastics. The experimental arrangement can be designed to match different specimen sizes. Measurements can be made in gaseous and vacuum environments at a range of temperatures and pressures.

This method gives guidelines for testing homogeneous and isotropic materials, as well as anisotropic materials with a uniaxial structure. The homogeneity of the material extends throughout the specimen and no thermal barriers (except those next to the probe) are present within a range defined by the probing depth(s) (see 3.1).

The method is suitable for materials having values of thermal conductivity, λ, in the approximate range 0,010 W·m^{-1}·K^{-1} < λ < 500 W·m^{-1}·K^{-1}, values of thermal diffusivity, α, in the range 5 × 10^{-8} m^2·s^{-1} < α < 10^{-4} m^2·s^{-1}, and for temperatures, T, in the approximate range 50 K < T < 1 000 K.

NOTE 1　The specific heat capacity per unit volume, C, $C = \rho \cdot c_p$, where ρ is the density and c_p is the specific heat per unit mass and at constant pressure, can be obtained by dividing the thermal conductivity, λ, by the thermal diffusivity, α, i.e. $C = \lambda/\alpha$, and is in the approximate range 0,005 MJ·m^{-3}·K^{-1} < C < 5 MJ·m^{-3}·K^{-1}. It is also referred to as the volumetric heat capacity.

NOTE 2　If the intention is to determine the thermal resistance or the apparent thermal conductivity in the through-thickness direction of an inhomogeneous product (for instance a fabricated panel) or an inhomogeneous slab of a material, reference is made to ISO 8301, ISO 8302 and ISO 472.

The thermal-transport properties of liquids can also be determined, provided care is taken to minimize thermal convection.

2 Normative references

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

ISO 22007-1, *Plastics — Determination of thermal conductivity and thermal diffusivity — Part 1: General principles*

3 Terms and definitions

For the purposes of this document, the terms and definitions given in ISO 22007-1 and the following apply.

ISO and IEC maintain terminological databases for use in standardization at the following addresses:

— ISO Online browsing platform: available at https://www.iso.org/obp

— IEC Electropedia: available at https://www.electropedia.org/

3.1
probing depth

d_p

measure of how far into the specimen, in the direction of heat flow, a heat wave has travelled during the time window used for calculation

Note 1 to entry: The probing depth is given by:

$$d_p = \kappa \sqrt{\alpha \cdot t_{max}}$$

where

t_{max} is the maximum time of the time window used for calculating the thermal-transport properties;

α is the thermal diffusivity of the specimen material;

κ is a constant dependent on the sensitivity of the temperature recordings.

Note 2 to entry: It is expressed in metres (m).

Note 3 to entry: A typical value in hot disc measurements is $\kappa = 2$, which is assumed throughout this document.

3.2
sensitivity coefficient

β_Ψ

coefficient defined by the formula

$$\beta_\Psi = \Psi \frac{\partial[\Delta T(t)]}{\partial \Psi}$$

where

Ψ is the thermal conductivity, λ, the thermal diffusivity, α, or the volumetric specific heat capacity, C;

$\Delta T(t)$ is the mean temperature increase of the probe.

Note 1 to entry: Different sensitivity coefficients are defined for thermal conductivity, thermal diffusivity, and specific heat per unit volume[7].

Note 2 to entry: To define the time window that is used to determine both the thermal conductivity and diffusivity from one single experiment, the theory of sensitivity coefficients is used. Through this theory, which deals with a large number of experiments and considers the constants, Ψ, as variables, it has been established that

$$0,30 < t_{max} \cdot \alpha / r^2 < 1,0$$

where r is the mean radius of the outermost spiral of the probe.

Assuming $\kappa = 2$, this expression can be rewritten as:

$1,1r < d_p < 2,0r$.

4   Principle

A specimen containing an embedded hot disc probe of negligible heat capacity shall be equilibrated at a given temperature. A heat pulse in the form of a stepwise function is produced by an electrical current through the probe to generate a dynamic temperature field within the specimen. The increase in the temperature of the probe is measured as a function of time. The probe operates as a temperature sensor

unified with a heat source (i.e. a self-heated sensor). The response is then analysed in accordance with the model developed for the specific probe and the assumed boundary conditions.

5 Apparatus

5.1 A schematic diagram of the apparatus is shown in Figure 1.

Key

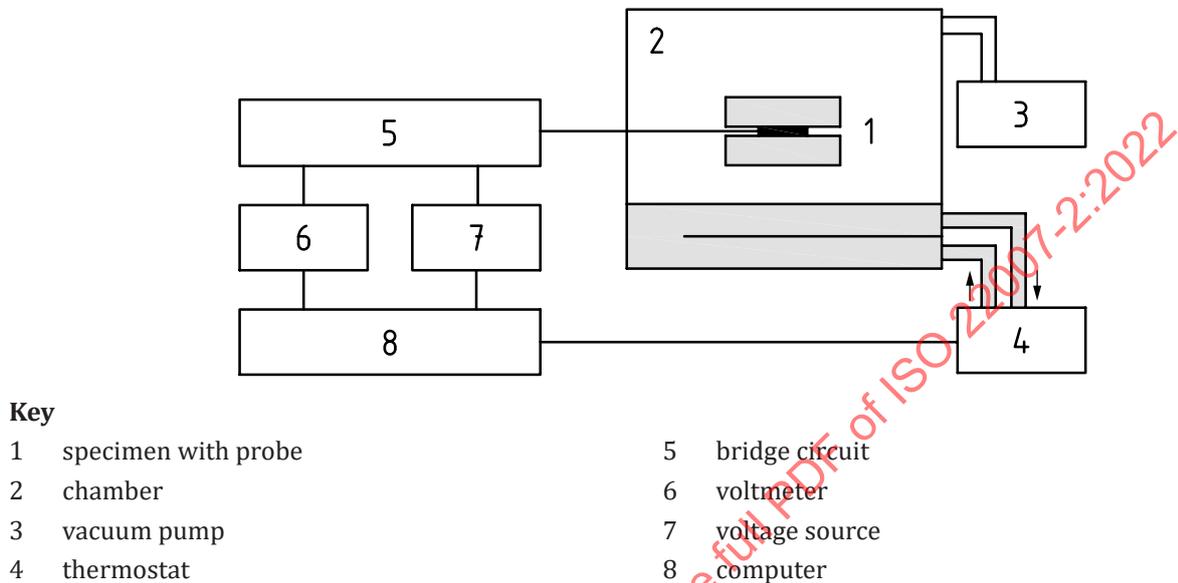|			
1	specimen with probe	5	bridge circuit
2	chamber	6	voltmeter
3	vacuum pump	7	voltage source
4	thermostat	8	computer

Figure 1 — Basic layout of the apparatus

5.2 A typical hot disc probe is shown in Figure 2. Convenient probes can be designed with diameters from 2 mm to 200 mm, depending on the specimen size and the thermal-transport properties of the material to be tested. The probe is constructed as a bifilar spiral etched out of a (10 ± 2) µm thick metal foil and covered on both sides by thin (from 7 µm to 100 µm) insulating film. Nickel or molybdenum should be used as the heater/temperature-sensing metal foil due to their relatively high temperature coefficient of electrical resistivity and stability over a wide temperature range. Polyimide, mica, aluminium nitride or aluminium oxide should be used as the insulating film, depending on the ultimate temperature of use. The arms of the bifilar spiral forming an essentially circular probe shall have a width of $(0,20 \pm 0,03)$ mm for probes with an overall diameter of 15 mm or less and a width of $(0,35 \pm 0,05)$ mm for probes of larger diameter. The distance between the edges of the arms shall be the same as the width of the arms.
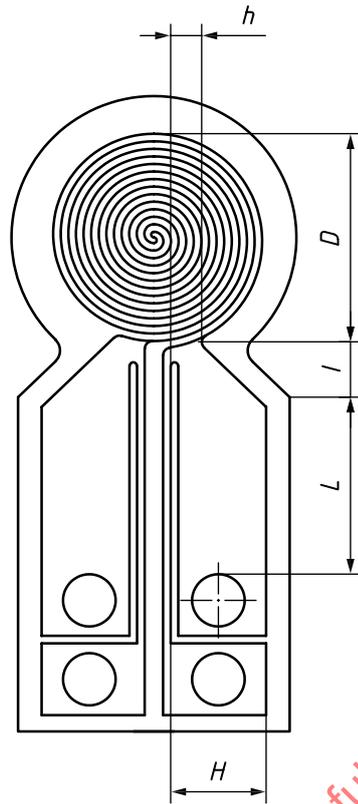
Key

D   sensor diameter

H, h, L, l   dimensions of sensor details

The distances indicated in this figure shall be measured in any but the same unit of length, when used to calculate the heat loss through the electrical leads according to 8.5.2.

Figure 2 — Hot disc probe with bifilar spiral as heating/sensing element

5.3   An electrical bridge shall be used to record the transient increase in resistance of the probe. Through the bridge, which is initially balanced, the increase in resistance of the probe shall be followed by recording the imbalance of the bridge with a sensitive voltmeter (see Figure 3). With this arrangement, the probe is placed in series with a resistor which shall be designed in such a way that its resistance is kept strictly constant throughout the transient. These two components are combined with a precision potentiometer, the resistance of which shall be about 100 times larger than the sum of the resistances of the probe and the series resistor. The bridge shall be connected to a power supply which can supply 20 V and a current of up to 1 A. The digital voltmeter by which the difference voltages are recorded shall have a resolution corresponding to 6,5 digits at an integration time of 1 power line cycle.

The resistance of the series resistor, R_S, shall be close to the initial resistance of the probe with its leads, $R_0 + R_L$, in order to keep the power output of the probe as constant as possible during the measurement.
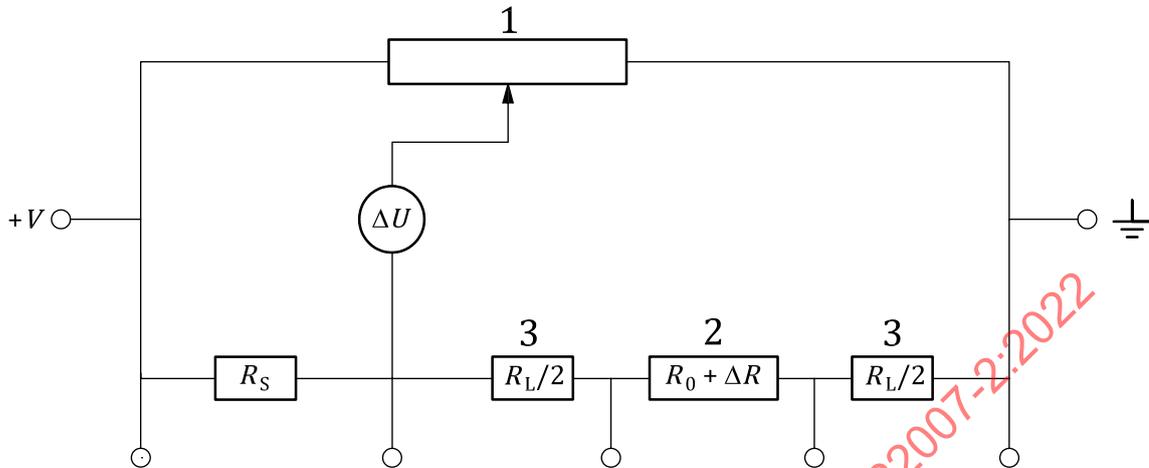
Key

1   potentiometer

2   probe

3   probe leads

R_L total resistance of the probe leads

R_S series resistance

R_0 initial resistance of the probe before initiating the transient heating

ΔR increase in resistance of the probe during the transient heating

ΔU voltage imbalance created by the increase in the resistance of the probe

NOTE   This experimental arrangement allows the determination of temperature deviations from the iterated straight line (see treatment of experimental data in 8.1) down to or better than 50 µK.

Figure 3 — Diagram of electrical bridge for recording the resistance increase of the probe

5.4   A constant-temperature environment controlled to ±0,1 K or better for the duration of a measurement shall be established (see Figure 1). The chamber need only be evacuated when working with slab specimens (see 6.3).

6   Test specimens

6.1   Bulk specimens

6.1.1   For bulk specimens, the requirement for specimen thickness depends on the thermal properties of the material from which the specimen is made. The expression for the probing depth contains the diffusivity, which is not known prior to the measurement. This means that the probing depth shall be calculated after an initial experiment has been completed. If, with this new information, the probing depth is found to be outside the limits given in 8.1.3, the test shall be repeated, with an adjusted total measurement time, until the required conditions are fulfilled.

The shape of the specimen can be cylindrical, square, or rectangular. Machining to a certain shape is not necessary, as long as a flat surface (see 6.1.4) on each of the two specimen halves faces the sensor and the requirements regarding sensor size given in 8.1.3 are fulfilled.

6.1.2   The measurement shall be conducted in such a way that the probing depth into the specimen shall be at least 20 times the characteristic length of the components making up the material or of any inhomogeneity in the material, such as the average diameter of the particles if the specimen is a powder.

6.1.3 The specimen dimensions shall be chosen to minimize the effect that its outer surfaces will have on the measurement. The specimen size shall be such that the distance from any part of the bifilar spiral of the hot disc probe to any part of the outside boundary of the specimen is larger than the overall mean radius of the bifilar spiral (see 5.2). An increase in this distance beyond the size of the diameter of the spiral does not improve the accuracy of the results.

6.1.4 Specimen surfaces which are in contact with the sensor shall be plane and smooth. The specimen halves shall be clamped on to both sides of the hot disc probe.

Heat sink contact paste shall not be used since:

a) it is difficult to obtain a sufficiently thin layer of paste which will actually improve the thermal contact;

b) the paste obviously increases the heat capacity of the insulating layer and delays the development of the constant temperature difference between the sensing material and the specimen surface;

c) it is difficult to obtain exactly the same thickness of paste on both sides of the probe and achieve a strictly symmetrical flow of heat from the heating/sensing material through the insulation into the two specimen halves.

6.1.5 For liquids, suitable containment vessels with adequate seals are necessary and air bubbles and evaporation shall be avoided.

Storage and conditioning of the liquid can affect its properties, for example, by absorption of water or gas. It can be necessary to pre-treat the specimen prior to testing, for example by degassing. However, pre-treatment procedures shall not be used when they can detrimentally affect the material to be tested, for example through degradation.

6.1.6 For materials prone to significant dimensional changes whether instigated by measurements over large temperature ranges, thermal expansion, change of state, phase transition, or other causes, care shall be taken to ensure that when placing the hot disc probe in contact with the specimen, the applied load does not affect the properties of the specimen.

With soft materials, the clamping pressure shall not compress the specimen and thus change its thermal-transport properties.

6.1.7 The specimen shall be conditioned in accordance with the standard specification which applies to the type of material and its particular use.

6.2 Anisotropic bulk specimens

6.2.1 If a material is anisotropic, specimens shall be cut (or otherwise prepared) so that the probe can be oriented in the main directions (e.g. the fibre directions in reinforced plastics, the main directions in layered structures or the principal axes in crystals)[4],[8]. The hot disc method is limited to materials in which the thermal properties along two of the orthogonal and principal axes are the same, but are different from those along the third axis.

6.2.2 The size of anisotropic specimens shall be chosen so that the requirements of 8.1.3 are fulfilled along the principal axes.

6.3 Slab specimens

The so-called slab method is used with sheet-formed specimens extending in two dimensions, but with a limited and well-defined thickness in a range from 1 mm to 10 mm[9]. The slab specimen thickness shall be known to an accuracy of 0,01 mm. When two equally thick slabs of a material are clamped around a probe and thermally insulated on the outer sides, it is possible to measure the thermal conductivity and

diffusivity of such specimens. The condition related to the probing depth shall be fulfilled in the plane of the probe but not in the through-thickness direction. This method is particularly suited to studies of materials having thermal conductivities higher than 10 W·m^{-1}·K^{-1} but can also be used for materials with thermal conductivities as low as 1 W·m^{-1}·K^{-1}, provided good thermal insulation of the slabs can be arranged (for instance by performing the measurements in a vacuum).

6.4 Thin-film specimens

The so-called thin-film method is used with specimens such as paper, textiles, polymer films or deposited thin-film layers (such as ceramic coatings) with thicknesses ranging from 0,05 mm to about 5,0 mm[10]. The thickness of thin-film specimens (placed on both sides of the probe) shall be known to an accuracy of ±1 µm.

NOTE 1   When making a measurement on a material with a high thermal conductivity the temperature undergoes a rapid increase at the very beginning of the transient followed by a much more gradual increase. The insulating layer, between which the sensing spiral is sandwiched, causes this rapid increase. It has been shown both experimentally and in computer simulations that the temperature difference across the insulating layer becomes constant within a very short time and remains constant throughout the measurement. The reason is that the total power output, the area of the sensing material and the thickness of the insulating layer are constant in the test.

If thin films of a material are placed between the probe and a high-conductivity background material (in the form of an "infinite" solid), it is possible to measure the apparent thermal conductivity of the film material, provided that the apparent thermal conductivity of the insulating layer with which the probe is covered has been determined in a separate experiment[10].

NOTE 2   It can be necessary to make measurements on films of different thicknesses and the same properties or with different clamping pressures to eliminate mathematically the influence of thermal contact resistances.

The thermal conductivity of the background material shall be approximately 10 times greater than that of the thin-film material.

In order to better simulate a plane heat source when testing thin films, a probe similar to the one depicted in Figure 2 shall be used. However, the circular strips should preferably have a width of 0,8 mm and the openings between the strips should only be 0,2 mm. When using a probe with thermal insulation on both sides of the bifilar spiral, an initial test to determine the effective thermal conductivity of the insulation and the adhesive holding the probe together shall be carried out.

7 Procedure

7.1   Place the probe between the plane surfaces of two specimen halves of the material whose thermal properties are to be determined. There is no requirement regarding the shape of the outside surfaces as long as the condition related to the probing depth is fulfilled (see 8.1.3).

Clamp or assemble the specimen/probe assembly securely in the test rig.

When studying liquids, the probe is simply dipped into the liquid, often with an arrangement to keep the probe flat.

NOTE   The total temperature increase in the specimen is normally less than 2 K. This means that the thermodynamic state of the material under test hardly changes during the measurement process and the thermal properties can thus be ascribed to the equilibrium temperature attained prior to the test.

7.2   Assemble the complete system in a constant-temperature chamber and allow it to attain temperature stability as defined in 5.4.

7.3   Balance the electrical bridge prior to the test. For a probe with an initial resistance between 1 Ω and 50 Ω, the voltage for balancing the bridge shall be selected such that the current does not exceed 1 mA.

7.4   Apply the heat pulse and record the temperature during a predetermined measuring time. Use values provided in Table 1 as an initial guide for the power output and the measurement time.

In general, a lower power output is preferred in order to minimize the perturbation of the system. However, the sensitivity of the temperature recording increases when the power output (and consequently the current) is higher, which is the case when studying materials with high thermal conductivity. For this reason, it is possible to obtain good precision in measurements on such materials even with temperature increases of only a fraction of a degree.

7.5   The voltage imbalance is determined and recorded at appropriate time intervals over the duration of the measurement time. It is recommended that the frequency of data acquisition be such that at least 100 data points are collected during the measurement time. If the method is used to measure the thermal-transport properties of liquids, the measurement time shall be limited to 1 s, so that thermal convection in the liquid does not perturb the measurement.

Table 1 — Summary of recommended experimental parameters for a range of materials with different thermal conductivities

	Metal alloy	Dense ceramic	Steel	Ceramic	Polymer	Insulating material
Thermal conductivity [W/(m·K)]	170	40	14	1,5	0,19	0,028
Thermal diffusivity (mm²/s)	69	11	3,7	0,96	0,11	0,75
Temperature increase (K)	0,3	0,5	1,0	0,8	1,3	2,5
Probe radius (mm)	15	6,4	6,4	6,4	6,4	15
Specimen thickness (mm)	30	10	10	10	15	30
Specimen diameter (mm)	90	40	40	40	40	90
Measurement time (s)	5	10	10	40	160	160
Power output (W)	4	3	2	0,5	0,25	0,1

7.6   The temperature resolution of the equipment shall be better than 0,001 K.

7.7   Calculate the temperature increase from the voltage readings, $\Delta U(t)$, using Formula (1):

$$\Delta T(t) = (R_S + R_L + R_0)\,\Delta U(t)\,[J_0 R_S - \Delta U(t)]^{-1}\,(a R_0)^{-1} \tag{1}$$

where

R_L is the total resistance of the leads;

R_S is the series resistance (see 5.3);

R_0 is the initial resistance of the probe;

a is the temperature coefficient of resistance (TCR) of the probe;

J_0 is the current through the sensor at the start of the transient; this current can easily be determined by measuring the voltage across the bridge at the end of the transient before the heating current is turned off and dividing by $(R_S + R_L + R_0)$[1].

7.8 Change the test temperature successively to cover the desired temperatures for the specimen, making sure that temperature equilibrium is reached at each temperature.

Multiple measurements under the same experimental conditions should preferably be undertaken. At least three are recommended at the same temperature. Each consecutive measurement should be made after the system has stabilized at the initially chosen temperature. The time to reach thermal equilibrium will vary depending on specimen size, form, and thermal properties.

Upon completion of the test at the highest temperature, it is recommended that a repeat measurement be made after cooling to one or more lower temperatures. This makes it possible to detect any degradation in the specimen properties that might have occurred due to exposure to elevated temperatures.

7.9 The thermal conductivity shall be reported along with the conditions under which it was measured, such as temperature and pressure. The cardinal directions of the material and their orientations in relation to the plane surface of the specimen shall be reported whenever a material is anisotropic.

8 Calculation of thermal properties

8.1 Bulk specimens

8.1.1 For small increases in the temperature of the probe, see Formula (2):

$$R(t) = R_0 \left[1 + a \cdot \Delta T(t) \right] \tag{2}$$

where

$\Delta T(t)$ (= $T(t) - T_0$) is the mean temperature increase of the probe;

R_0 is the initial resistance of the probe at temperature T_0;

a is the temperature coefficient of resistance (TCR) of the probe.

The temperature increase can be seen as consisting of two parts. One part represents the temperature difference across the intercalated insulating layer and the other part the temperature increase of the specimen surface during the transient measurement. This can be expressed as shown in Formula (3):

$$\Delta T(t) = \Delta T_i(t) + \Delta T_s(t) \tag{3}$$

where

$\Delta T_i(t)$ is the increase in temperature over the insulating layers of the probe;

$\Delta T_s(t)$ is the increase in the temperature of the specimen surface.

With the assumption that the bifilar probe can be approximated by a number of concentric and equally spaced circular line sources, the solution of the thermal conductivity equation (see Reference [1]) is given by Formulae (4) to (6):

$$\Delta T_s(\tau) = P_0 \left(\pi^{3/2} r \lambda \right)^{-1} D(\tau) \tag{4}$$

where

P_0 is the power output of the probe;

r is the radius of the outermost ring source;

λ is the thermal conductivity of the specimen material;

τ is defined as

$$\tau = (t/\theta)^{1/2} \tag{5}$$

where

θ ($= r^2/\alpha$) is the characteristic time of the experiment;

$D(\tau)$ is the dimensionless specific time function, defined as

$$D(\tau) = [m(m+1)]^{-2} \int_0^{\tau} \sigma^{-2} \left[\sum_{l=1}^{m} l \sum_{k=1}^{m} k \exp\left(\frac{-\left(l^2 + k^2\right)}{4m^2\sigma^2} \right) I_0\left(\frac{lk}{2m^2\sigma^2} \right) \right] d\sigma \tag{6}$$

where

m is the number of concentric ring sources;

σ is the integration variable;

I_0 is a modified Bessel function.

Typical values of $D(\tau)$ are given in Figure 5.

A time correction, t_c, shall be introduced because of unavoidable hardware and software delays. This means that the development of the full power output of the probe does not coincide exactly with the time $t = 0$, and a time correction shall be introduced accordingly. This is accomplished by replacing τ by τ_c in Formula (5), which gives Formula (7):

$$\tau_c = [(t - t_c)/\theta]^{1/2} \tag{7}$$

Typical time corrections are a fraction of a second and shall not be larger than 0,5 % of the total measurement time.

NOTE 1 $\Delta T_i(t)$ becomes constant after a short time provided the insulating layer is thin and the power output is constant. The time it takes to approach this constant value is determined by the relaxation time, δ^2/α_i, where δ is the thickness of the insulating layer and α_i is the thermal diffusivity of the layer. For a typical insulated probe, the relaxation time is less than 10 ms and the time required to reach a constant temperature difference is less than 100 ms.

NOTE 2   The possibility of determining the thermal contact resistance experimentally via the initial temperature difference, $\Delta T_i(t)$, enables the true bulk properties of the specimen material to be determined.

NOTE 3   If the thermal diffusivity and time correction are known (see 8.1.2), there is a linear relationship between the temperature increase, $\Delta T_s(t)$, and $D(\tau)$ [see Figure 4 b)] where, in the example given, $\Delta T_i = 0{,}656\,6$ (K) and $\Delta T_s(t) = 1{,}894 D(\tau)$ (K).

8.1.2   The calculation of thermal conductivity and diffusivity starts with an iteration procedure with the diffusivity, α, and the time correction, t_c, as optimization variables. Through iteration, a linear relationship between $\Delta T_s(t)$ and $D(\tau)$ is established (by a least-squares fitting procedure) and the diffusivity and time correction are obtained from the final step of the iteration procedure. Finally, λ is determined from the slope of this line [see Formula (4) and Formula (5)].

8.1.3   The initial time window selected for the analysis can result in experimental points deviating from a straight line [see Figure 4 b)]. By removing deviating data points, a correct time window is obtained for the analysis. The graph of residuals [see Figure 4 c)] clearly displays the deviating points.

As the specimen is of limited size, its boundaries might, after some time, affect the temperature increase. This deviation becomes apparent in the graph of residuals [see Figure 4 c)] and, if there are deviating points at the end of the transient, these shall also be deleted.

The model fitting has been performed on the solid black points [see Figure 4 a) and Figure 4 b)]. The mean deviation of these points from the fitted straight line is 30 μK [see Figure 4 c)].

In view of the statistical nature of the expression used for the probing depth, it can be stated that the probing depth will have to be larger than the radius but less than the diameter of the bifilar spiral of the probe according to the theory of sensitivity coefficients in order to determine both the thermal conductivity and the thermal diffusivity from one single transient recording.
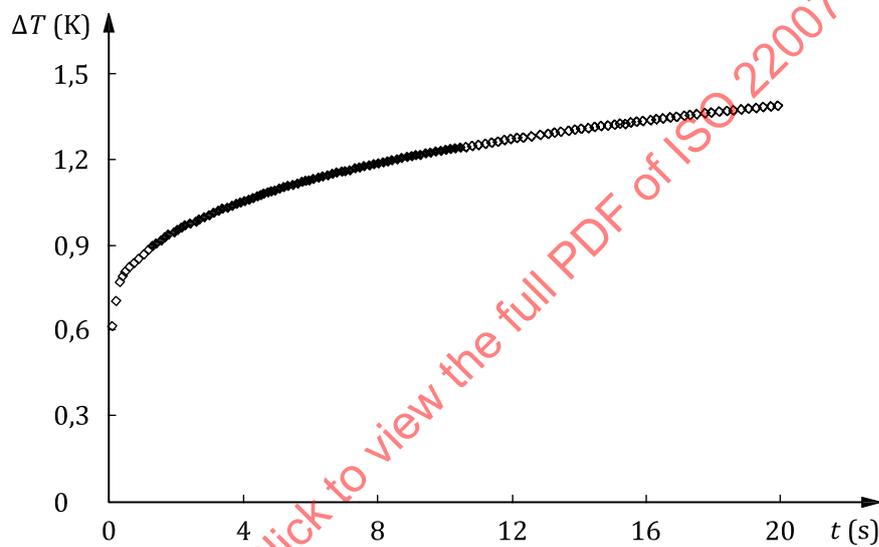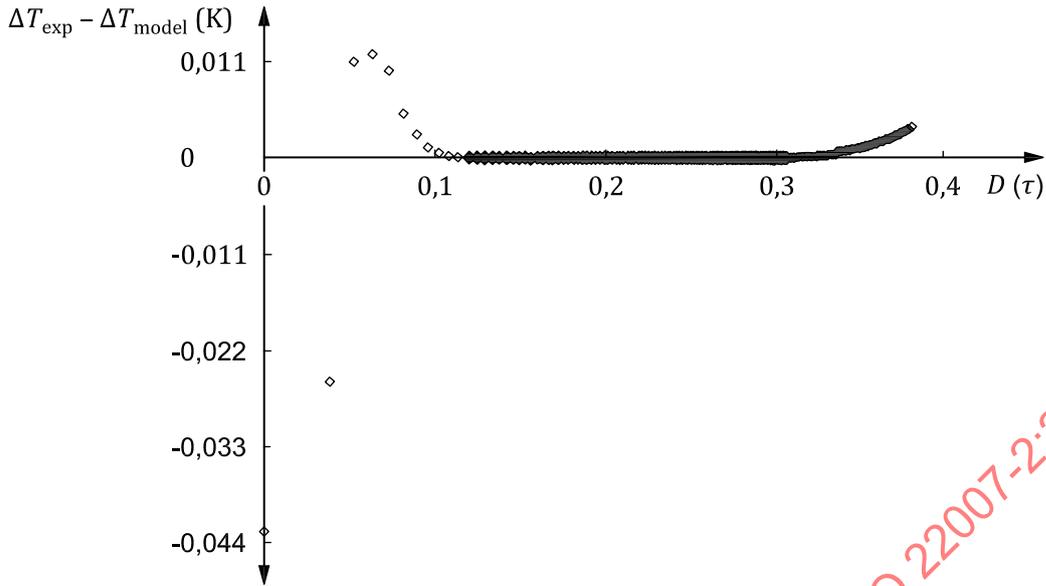

a) Temperature increase versus time
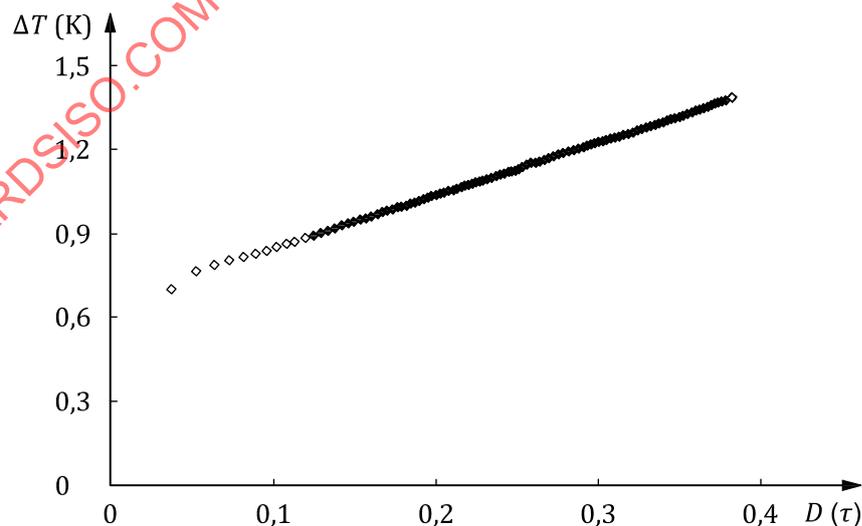
$$\Delta T = 1{,}894 D(\tau) + 0{,}656\,6\ (K)$$

$$R^2 = 0{,}999\,999\,913$$

b) Temperature increase versus $D(\tau)$

c) Temperature residuals versus $D(\tau)$

Key

$D(\tau)$	specific time function
R^2	correlation coefficient
t	time
ΔT	temperature increase
$\Delta T_{exp} - \Delta T_{model}$	temperature residual

Figure 4 — Various temperature increase/time plots

8.2 Anisotropic bulk specimens

For anisotropic materials, a separate determination of specific heat and density is required since the specific heat capacity per unit volume is necessary to calculate the thermal properties. If the properties along the a- and b-axes are the same, but different from those along the c-axis, and if the plane of the probe is mapped out by the a- and b-axes, the following expression [see Formulae (8) and (9)] for the temperature increase applies:

$$\Delta T_s(\tau_a) = P_0 \left[\pi^{3/2} r (\lambda_a \lambda_c)^{1/2} \right]^{-1} D(\tau_a) \tag{8}$$

where

λ_a is the thermal conductivity along the a-axis;

λ_c is the thermal conductivity along the c-axis.

$$\tau_a = (t/\theta_a)^{1/2} \tag{9}$$

where θ_a (= r^2/α_a) is the characteristic time of the experiment.

An iteration, similar to the one presented in 8.1, will give the thermal diffusivity, α_a, along the a-axis. If the specific heat capacity per unit volume, C, is known, then

$$\lambda_a = C \cdot \alpha_a \tag{10}$$

From the slope of the line corresponding to Formula (8), λ_c can be obtained since λ_a is known from Formula (10). Finally, the thermal diffusivity along the c-axis can be calculated from the standard relationship.

It is consequently possible to obtain the thermal conductivity and the thermal diffusivity in the principal directions in a uniaxial material from one single transient measurement, provided the specific heat capacity and density of the specimen are known.

8.3 Slab specimens

When solving the thermal-conductivity equation, the mathematical "method of images" has been used, with the assumption that no heat loss occurs from the upper and lower faces or the edges of the two specimen halves. The temperature increase can then be expressed as Formulae (11) and (12):

$$\Delta T_s(\tau) = P_0 \left(\pi^{3/2} r \lambda \right)^{-1} E(\tau) \tag{11}$$

where

$$E(\tau) = \left[m(m+1) \right]^{-2} \int_0^\tau \sigma^{-2} \left[\sum_{l=1}^m l \sum_{k=1}^m k \exp\left(\frac{-(l^2+k^2)}{4m^2\sigma^2} \right) I_0\left(\frac{lk}{2m^2\sigma^2} \right) \right] \left\{ 1 + 2\sum_{i=1}^\infty \exp\left[-\frac{i^2}{\sigma^2}\left(\frac{h}{r} \right)^2 \right] \right\} d\sigma \tag{12}$$

h is the thickness of each of the two slabs;

σ is the integration variable.

Making the measurement in a vacuum or in still air normally fulfils the condition that the heat loss from the upper and lower faces and the edges of the specimen shall be negligible. Figure 5 depicts $D(\tau)$ and examples of $E(\tau)$ functions.
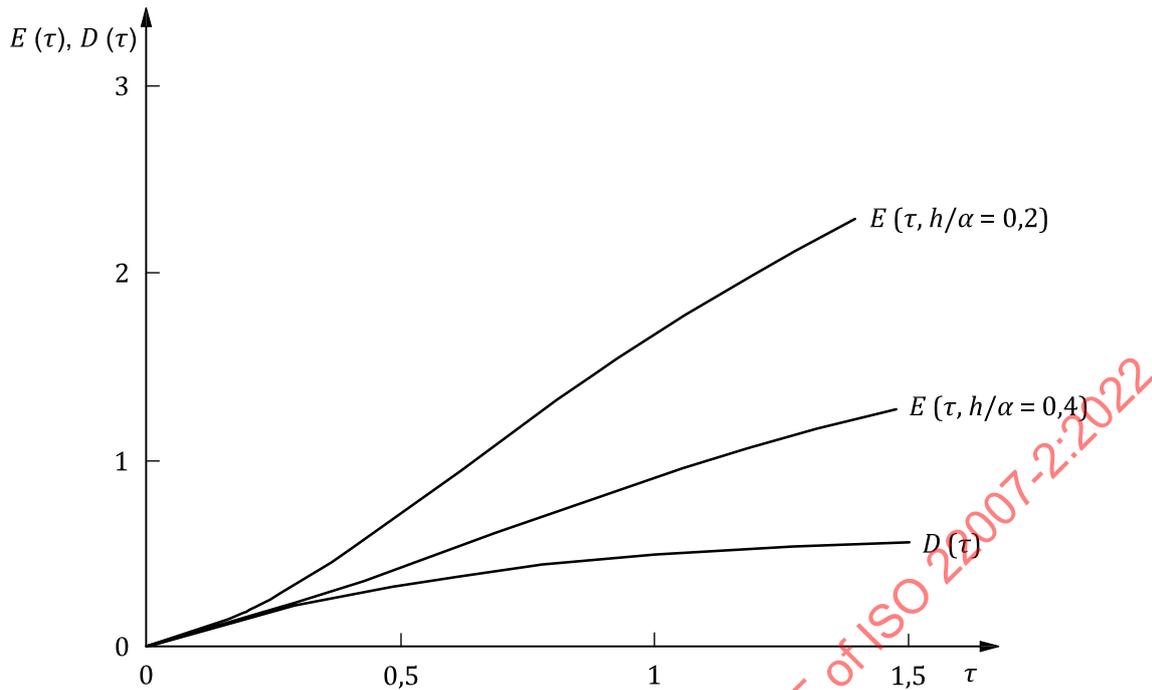
NOTE   In all three cases, it has been assumed that the number of concentric ring sources is 10.

Figure 5 — $D(\tau)$ and $E(\tau)$ functions plotted for values of τ up to 1,5

8.4   Thin-film specimens

The theory for thin-film specimens follows directly from the Formula (2) and Formula (3) and the measurement of the temperature increase, $\Delta T_i(t)$, over the insulating layer. By extrapolating the iterated straight line to zero time, the constant temperature increase, ΔT_i, is obtained from Formula (13).

$$P_0 = 2A\lambda_i \left(\Delta T_i / \delta \right) \tag{13}$$

the thermal conductivity of the insulating layer, λ_i, can be calculated, where

A is the area of the probe;

δ is the thickness of the insulating layers.

When a probe with insulation outside the bifilar spiral of the sensing material is used (see 6.4), it is necessary to make two transient recordings to determine the thermal conductivity of the thin-film material. The first test is made with the probe itself between the plane surfaces of the high-conducting material and the second is made with the two thin-film specimens placed between the probe and the surfaces of the high-conducting material. From these tests, two thermal conductivities are determined, viz. λ_{pr}, which is the thermal conductivity of the insulating layer of the probe together with the adhesive used to attach the insulating layers to the bifilar spiral, and λ_{tot}, which is the thermal conductivity of the combination of the probe insulation and the thin-film specimens. To calculate the thermal conductivity of the thin-film specimen, λ_{sp}, Formula (14) shall be used:

$$\frac{\delta_{pr} + \delta_{sp}}{\lambda_{tot}} = \frac{\delta_{pr}}{\lambda_{pr}} + \frac{\delta_{sp}}{\lambda_{sp}} \tag{14}$$

where

δ_{pr} is the thickness of the probe insulation on one of the sides, together with its adhesive;

δ_{sp} is the thickness of one of the specimens.

8.5 Low thermally conducting specimens

8.5.1 Introductory remarks

Using of the hot disc method, it is possible to obtain the true bulk thermal transport properties of a homogeneous material. Apparent thermal conductivity of non-homogeneous thin specimens can also be measured in the "through" direction with the hot disc method (see 6.4 and 8.4). Such measurements require specially designed probes and are limited to a thickness of less than 5 mm.

Materials with thermal transport properties lower than those of certified materials should be studied and compared in interlaboratory tests.

8.5.2 Low thermally conducting bulk specimens

When analysing measurements on materials with low thermal conductivity and low volumetric heat capacity, it is necessary to employ a slightly modified analysis of the transient recording.

This is due to a certain power loss in and from the probe during the transient recording, which includes the following:

a) heat capacity of the probe itself; and

b) heat loss through the electrical leads.

Following Reference [11], a good approximation of the power required to increase the temperature of the probe itself can be given as:

$$\Delta P_{pr}(\tau) = \frac{P_o \cdot d \cdot (\rho C_p)_{pr} \cdot \alpha}{2\pi^{\frac{1}{2}} r \cdot \lambda} \cdot \left(\frac{1}{\tau} \cdot \frac{dD(\tau)}{d\tau} \right) \tag{15}$$

where

$\Delta P_{pr}(\tau)$ is the power consumed by the probe itself during self-heating;

d is the total thickness of the probe;

$(\rho C_p)_{pr}$ is the heat capacity of the probe.

The volumetric heat capacity should be calculated as a weighted average based on the thickness of the sensing material (metal), the two insulating layers on the sides of the sensing material, as well as on the properties and the thickness of the adhesive used for keeping the thin layers/probe together.

With the assumption that the lead pattern is wide enough to avoid self-heating and if the etched-out electrical leads of the probe are of the shape depicted in Figure 2, the loss of power, $\Delta P_{\text{ld}}(\tau)$ is given by:

$$\Delta P_{\text{ld}}(\tau) = \frac{2 \cdot \gamma \cdot P_{\text{o}} \cdot d_{\text{m}} \cdot \lambda_{\text{m}} \cdot \left[\dfrac{\delta}{r \cdot \lambda_{\text{i}}} + \dfrac{D(\tau)}{\pi^{\frac{1}{2}} \cdot \lambda} \right]}{\pi \cdot r \cdot \left[\left(\dfrac{l}{H-h} \right) \cdot \ln\left(\dfrac{H}{h} \right) + \dfrac{L}{H} \right]} \tag{16}$$

where

d_{m} is the thickness of the metal used as sensing material of the probe. The influence from the thin insulating layers is neglected because of the considerable difference between the thermal conductivity of the metal and that of the insulating layers;

λ_{m} is the thermal conductivity of the sensing material;

H, h, L, l are given in Figure 2;

γ is a correction factor with a value between 0,1 and 1,0.

The final formula for evaluating the thermal transport properties is based on Formula (4) modified by the power loss given by Formula (15) and Formula (16).

$$\Delta T_{\text{S}}(\tau) = P_{\text{o}} \cdot \left(\pi^{\frac{3}{2}} \cdot r \cdot \lambda \right)^{-1} \cdot D(\tau) \cdot \left[1 - \frac{\Delta P_{\text{ld}}}{P_0} - \frac{\Delta P_{\text{pr}}}{P_0} \right] \tag{17}$$

The correction terms in Formula (17) are small, which makes it possible to use a "fixed point iteration" procedure, see Reference [12]. This procedure is necessary since the correction terms include both the thermal conductivity and the thermal diffusivity. The first step of the iteration should be to assume that the correction terms are zero, and from that assumption determine both transport coefficients. The next step should be to calculate the correction terms using the approximate transport coefficients already determined. The iteration process should then be repeated and terminated when the difference between the transport properties determined during one iteration step and that of the ensuing iteration is less than 0,5 %.

To simplify the work with correction terms it has been assumed in Formula (16) that the heat flow from the probe through the electrical leads is controlled by the mean temperature increase of the probe. However, the heat flow is in fact controlled by the temperature increase of the outer-most ring source of the probe. To compensate for this slight over-estimation, it is convenient to introduce the γ as a correction factor.

A homogenous standard reference material (or a material with certified properties) with low thermal conductivity should be used to determine the correction factor, γ. Three separate experiments should be performed, using the same mean temperature increase, and the correction factor should be calculated using Formula (16) and Formula (17). For actual measurements, the mean value of the 3 experimentally determined correction factors should be used.

Figure 2 depicts the bifilar spiral together with the electrical leads necessary for supplying power to the spiral and for recording the resistance increases during the transient recording. In Figure 2, certain geometrical distances have been defined, which are necessary for calculating the power loss from the sensing spiral through the electrical leads.

NOTE   The thin leads, by which the voltage increase of the spiral is recorded, are assumed to have the same width as the openings between the thin "voltage" leads and the wider leads carrying the heating current.